2N50K-TA **Preliminary Power MOSFET**

2A, 500V **N-CHANNEL POWER MOSFET**

DESCRIPTION

The UTC 2N50K-TA is an N-channel mode power MOSFET using UTC's advanced technology to provide customers with planar stripe and DMOS technology. This technology allows a minimum on-state resistance and superior switching performance. It also can withstand high energy pulse in the avalanche and commutation mode.

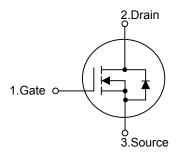
The UTC 2N50K-TA is generally applied in high efficiency switch mode power supplies, active power factor correction and electronic lamp ballasts based on half bridge topology.

TO-220 TO-220F TO-220F1 TO-220F2 TO-220F3 TO-251 TO-251S

FEATURES

- * $R_{DS(ON)}$ < 4.9 Ω @ V_{GS} =10V, I_{D} =1A
- * High Switching Speed
- * 100% Avalanche Tested

SYMBOL

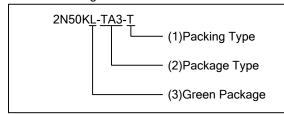


www.unisonic.com.tw 1 of 7 QW-R205-031.A

■ ORDERING INFORMATION

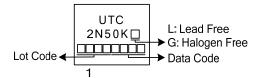
Ordering Number		Package	Pin Assignment			Packing	
Lead Free	Halogen Free	Fackage	1	2	3	i acking	
2N50KL-TA3-T	2N50KG-TA3-T	TO-220	G	D	S	Tube	
2N50KL-TF3-T	2N50KG-TF3-T	TO-220F	G	D	S	Tube	
2N50KL-TF1-T	2N50KG-TF1-T	TO-220F1	G	D	S	Tube	
2N50KL-TF2-T	2N50KG-TF2-T	TO-220F2	G	D	S	Tube	
2N50KL-TF3T-T	2N50KG-TF3T-T	TO-220F3	G	D	S	Tube	
2N50KL-TM3-T	2N50KG-TM3-T	TO-251	G	D	S	Tube	
2N50KL-TMS-T	2N50KG-TMS-T	TO-251S	G	D	S	Tube	
2N50KL-TN3-R	2N50KG-TN3-R	TO-252	G	D	S	Tape Reel	
2N50KL-TND-R	2N50KG-TND-R	TO-252D	G	D	S	Tape Reel	

Note: Pin Assignment: G: Gate D: Drain S: Source



- (1) T: Tube, R: Tape Reel
- (2) TA3: TO-220, TF3: TO-220F, TF1: TO-220F1, TF2: TO-220F2, TF3T: TO-220F3, TM3: TO-251, TMS: TO-251S, TN3: TO-252, TND: TO-252D (3) L: Lead Free, G: Halogen Free and Lead Free

■ MARKING



■ **ABSOLUTE MAXIMUM RATINGS** (T_C=25°C, unless otherwise specified)

PARAMETER		SYMBOL	SYMBOL RATINGS		
Drain-Source Voltage		V_{DSS}	500	V	
Gate-Source Voltage		V_{GSS}	V _{GSS} ±30		
Danier Orange at	Continuous (T _C =25°C)	I _D	2 (Note 3)	Α	
Drain Current	Pulsed (Note 2)	I _{DM}	8 (Note 3)	Α	
Avalanche Current (Note 2)		I _{AR}	2	Α	
	Single Pulsed	E _{AS}	82	mJ	
Avalanche Energy	Repetitive (Note 4)	E _{AR}	3.3	mJ	
	TO-220		52		
Power Dissipation (T _C =25°C)	TO-220F/TO-220F1 TO-220F3		23		
	TO-220F2	1 -	23.2	W	
	TO-251/TO-251S TO-252/TO-252D		50		
Derate above 25°C	TO-220	P _D	0.43		
	TO-220F/TO-220F1 TO-220F3		0.18	W/°C	
	TO-220F2	1	0.185		
	TO-251/TO-251S TO-252/TO-252D		0.4		
Junction Temperature		TJ	+150	°C	
Storage Temperature		T _{STG}	-55~+150	°C	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature
- 3. Drain current limited by maximum junction temperature
- 4. Pulse Test: Pulse width ≤ 300µs, Duty cycle ≤ 2%
- 5. L=41mH, I_{AS} =2.0A, V_{DD} =50V, R_{G} =25 Ω , Starting T_{J} = 25°C

■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT	
Junction to Ambient	TO-220/TO-220F TO-220F1/TO-220F2 TO-220F3	$ heta_{\sf JA}$	62.5	°C/W	
	TO-251/TO-251S TO-252/TO-252D		110		
Junction to Case	TO-220		2.36	0000	
	TO-220F/TO-220F1 TO-220F3	0	5.5		
	TO-220F2	$\theta_{ extsf{JC}}$	5.4	°C/W	
	TO-251/TO-251S TO-252/TO-252D		2.5		

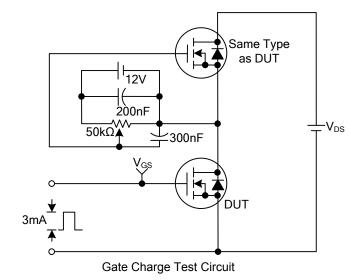
■ **ELECTRICAL CHARACTERISTICS** (T_C=25°C, unless otherwise noted)

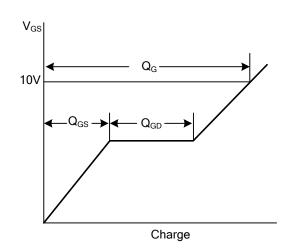
PARAMETER		SYMBOL	TEST CONDITIONS MIN		TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV_{DSS}	$I_D = 250 \mu A, V_{GS} = 0 V$	500			V
Drain-Source Leakage Current		I _{DSS}	V _{DS} =500V, V _{GS} =0V			25	μΑ
Gate- Source Leakage Current	Forward		V_{GS} =+30V, V_{DS} =0V			+100	nA
	Reverse	I _{GSS}	V_{GS} =-30V, V_{DS} =0V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$			5.0	V
Static Drain-Source On-State Re	esistance	R _{DS(ON)}	V _{GS} =10V, I _D =1A		2.6	4.9	Ω
DYNAMIC PARAMETERS					-		
Input Capacitance		C_{ISS}			200		pF
Output Capacitance Reverse Transfer Capacitance		C_{OSS}	V_{GS} =0V, V_{DS} =25V, f=1.0MHz		39		pF
		C_{RSS}			16		pF
SWITCHING PARAMETERS							
Total Gate Charge		Q_G	-\/ -10\/ \/ -400\/ -24		12	25	nC
Gate to Source Charge		Q_GS	V _{GS} =10V, V _{DS} =400V, I _D =2A (Note 1, 2)		5.6	3	nC
Gate to Drain Charge		Q_GD	(Note 1, 2)		2	15	nC
Turn-ON Delay Time		$t_{D(ON)}$			20		ns
Rise Time		t_R	V_{DD} =250V, I_{D} =2A, R_{G} =25 Ω		40		ns
Turn-OFF Delay Time		$t_{D(OFF)}$	(Note 1, 2)		84		ns
all-Time		t_{F}			38		ns
SOURCE- DRAIN DIODE RATI	NGS AND	CHARACTER	ISTICS		ā.		
Maximum Body-Diode Continuous Current		Is				2	Α
Maximum Body-Diode Pulsed Current		I _{SM}				8	Α
Drain-Source Diode Forward Voltage		V_{SD}	I _S =2A, V _{GS} =0V			1.2	V

Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle ≤ 2%

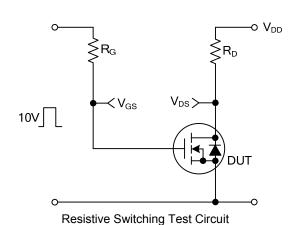
^{2.} Essentially independent of operating temperature

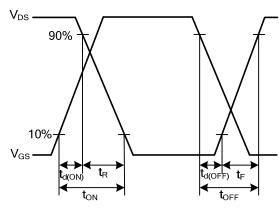
■ TEST CIRCUITS AND WAVEFORMS



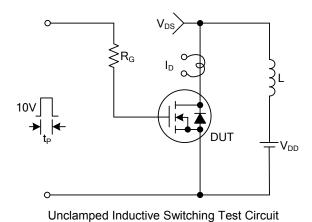


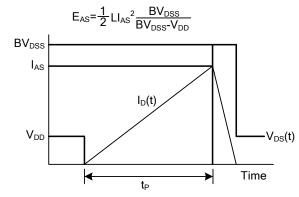
Gate Charge Waveforms





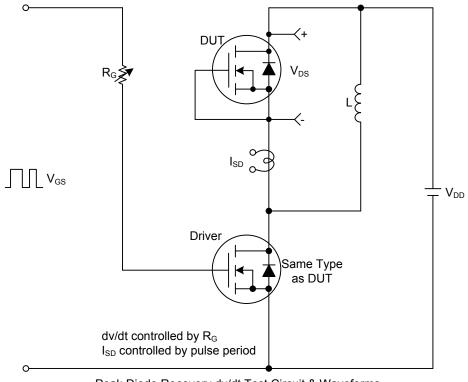
Resistive Switching Waveforms



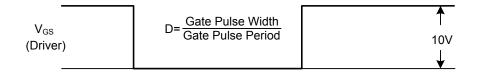


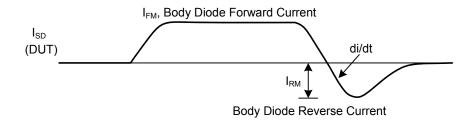
Unclamped Inductive Switching Waveforms

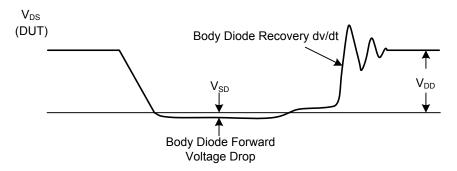
■ TEST CIRCUITS AND WAVEFORMS(Cont.)



Peak Diode Recovery dv/dt Test Circuit & Waveforms







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